CEL

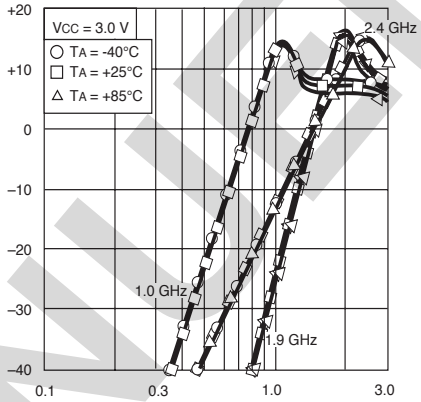
SILICON RFIC LOW CURRENT AMPLIFIER FOR MOBILE COMMUNICATIONS

UPC8179TB

FEATURES

- **HIGH DENSITY SURFACE MOUNTING:**
  6 Pin Super Minimold Package (2.0 x 1.25 x 0.9 mm)
- **SUPPLY VOLTAGE:**
  V_{CC} = 2.4 to 3.3 V
- **HIGH EFFICIENCY:**
  P_O(1dB) = +3.0 dBm TYP at f = 1.0 GHz
  P_O(1dB) = +1.5 dBm TYP at f = 1.9 GHz
  P_O(1dB) = +1.0 dBm TYP at f = 2.4 GHz
- **POWER GAIN:**
  G_P = 13.5 dB TYP at f = 1.0 GHz
  G_P = 15.5 dB TYP at f = 1.9 GHz
  G_P = 15.5 dB TYP at f = 2.4 GHz
- **EXCELLENT ISOLATION:**
  ISL = 44 dB TYP at f = 1.0 GHz
  ISL = 42 dB TYP at f = 1.9 GHz
  ISL = 41 dB TYP at f = 2.4 GHz
- **LOW CURRENT CONSUMPTION:**
  I_{CC} = 4.0 mA TYP AT VCC = 3.0 V
- **OPERATING FREQUENCY:**
  I_{CC} = 4.0 mA TYP AT VCC = 3.0 V
- **LIGHT WEIGHT:**
  7 mg (standard Value)

POWER GAIN vs. FREQUENCY



Output match for best performance at each frequency

APPLICATIOIN

- Buffer amplifiers for 0.1 to 2.4 GHz mobile communications systems.

DESCRIPTION

NEC's UPC8179TB is a silicon monolithic integrated circuit designed as amplifier for mobile communications. This IC can realize low current consumption with external chip inductor which can be realized on internal 50Ω wideband matched IC. This low current amplifier uns on 3.0 V. This IC is manufactured using NEC's 30 GHz fMAX UHS0 (Ultra High Speed Process) silicon bipolar process. This process uses direct silicon nitride passivation film and gold electrodes. These materials can protect the chip surface from pollution and prevent corrosion/ migration. Thus this IC has exellent performance uniformity and reliability.

ELECTRICAL CHARACTERISTICS,

(Unless otherwise specified, T_A = +25°C, V_{CC} = V_{OUT} = 3.0 V, Z_S = Z_L = 50Ω, at LC matched Frequency)

PART NUMBER PACKAGE OUTLINE				UPC8179TB S06		
SYMBOLS	**PARAMETERS AND CONDITIONS**		**UNITS**	**MIN**	**TYP**	**MAX**
I_{CC}	Circuit Current (no input signal)		mA	2.9	4.0	5.4
GP	Power Gain,	f = 1.0 GHz, P_{IN} = -30 dBm	dB	11.0	13.5	15.5
		f = 1.9 GHz, P_{IN} = -30 dBm		13.0	15.5	17.5
		f = 2.4 GHz, P_{IN} = -30 dBm		13.0	15.5	17.5
ISOL	Isolation,	f = 1.0 GHz, P_{IN} = -30 dBm	dB	39.0	44.0	–
		f = 1.9 GHz, P_{IN} = -30 dBm		37.0	42.0	–
		f = 2.4 GHz, P_{IN} = -30 dBm		36.0	41.0	–
P_{1dB}	Output Power at 1 dB gain compression,	f = 1.0 GHz	dB	-0.5	3.0	–
		f = 1.9 GHz		-2.0	1.5	–
		f = 2.4 GHz		-3.0	1.0	–
NF	Noise Figure,	f = 1.0 GHz	dB	–	5.0	6.5
		f = 1.9 GHz		–	5.0	6.5
		f = 2.4 GHz		–	5.0	6.5
RL_{IN}	Input Return Loss, (without matching circuit)	f = 1.0 GHz, P_{IN} = -30 dBm	dB	4.0	7.0	–
		f = 1.9 GHz, P_{IN} = -30 dBm		4.0	7.0	–
		f = 2.4 GHz, P_{IN} = -30 dBm		6.0	9.0	–

ABSOLUTE MAXIMUM RATINGS[1] (T_A = 25°C)

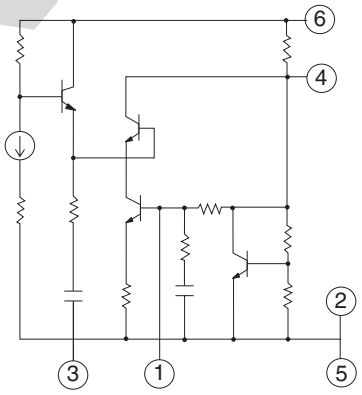
SYMBOLS	PARAMETERS	UNITS	RATINGS
V_{CC}	Supply Voltage, Pins 4 & 6	V	3.6
I_{CC}	Circuit Current	mA	15
P_D	Power Dissipation[2]	mW	270
T_{OP}	Operating Temperature	°C	-40 to +85
T_{STG}	Storage Temperature	°C	-55 to +150
P_{IN}	Input Power	dBm	+5

Notes:
1. Operation in excess of any one of these parameters may result in permanent damage.
2. Mounted on a 50 x 50 x 1.6 mm epoxy glass PWB (T_A = +85°C).

RECOMMENDED OPERATING CONDITIONS

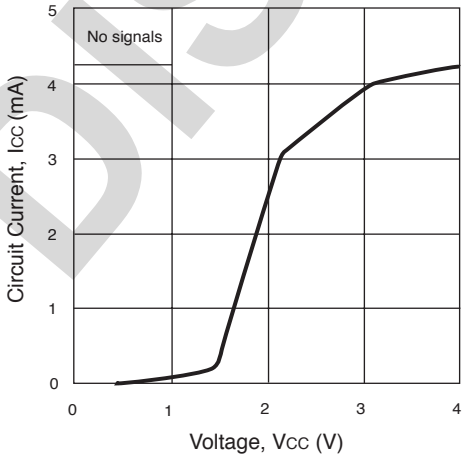
SYMBOLS	PARAMETERS	UNITS	MIN	TYP	MAX
V_{CC}	Supply Voltage	V	2.7	3.0	3.3
T_A	Operating Ambient Temperature	°C	-40	+25	+85

PIN FUNCTIONS

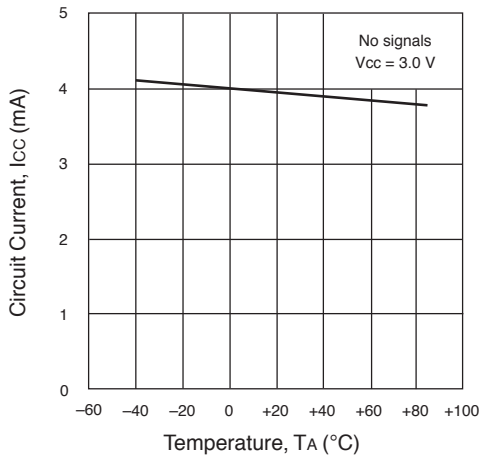
Pin No.	Symbol	Pin Voltage	Description	Internal Equivalent Circuit
1	INPUT	1.09 V	Signal Input Pin. A internal matching circuit, configured with resistors, enable 50 W connection over a wide band. This pin must be coupled to signal source with capacitor for DC cut.	
2 3 5	GND	through external inductor	Ground pin. This pin should be connected to the system ground with minimum inductance. Ground pattern on the board should be formed as wide as possible. All the ground pins must be connected together with wide ground pattern to decrease impedance difference.	
4	OUTPUT	Same as V_{CC} voltage	Signal output pin. This pin is designed as collector output. Due to the high impedance output, this pin should be externally equipped with matching LC matching circuit to next stage. For L, a size 1005 chip inductor can be chosen.	
6	V_{CC}	2.4 to 3.3	Power supply pin. This pin should be externally equipped with bypass capacitor to minimize its impedance.	

TYPICAL PERFORMANCE CURVES (Unless otherwise specified, T_A = 25°C)

CIRCUIT CURRENT vs. VOLTAGE



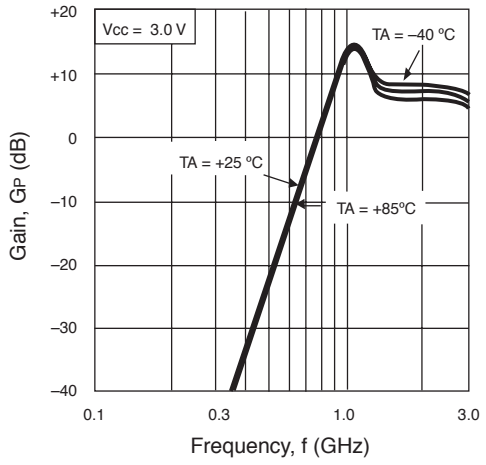
CIRCUIT CURRENT vs. TEMPERATURE



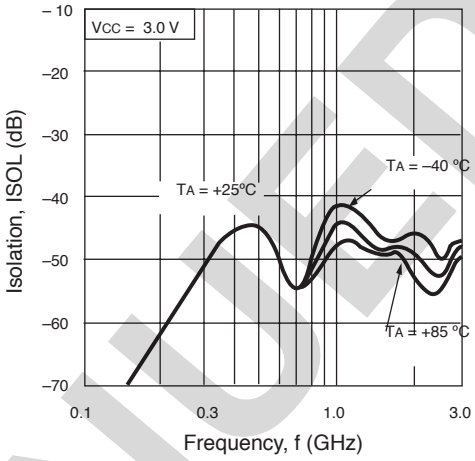
TYPICAL PERFORMANCE CURVES (Unless otherwise specified, T_A = 25˚C)

1.0 GHz Output Port Matching

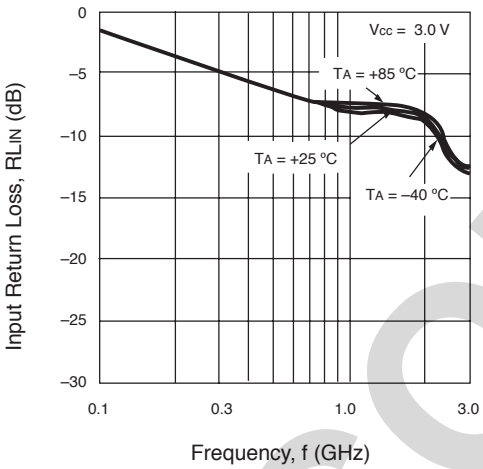
GAIN vs. FREQUENCY



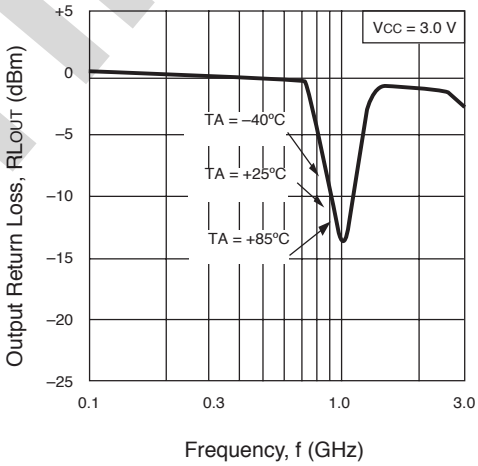
ISOLATION vs. FREQUENCY



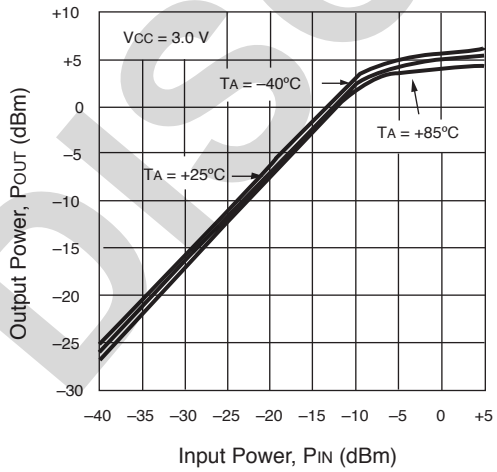
INPUT RETURN LOSS vs. FREQUENCY



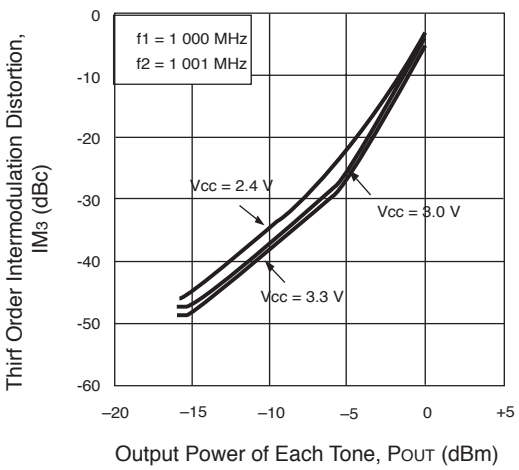
OUTPUT RETURN LOSS vs. FREQUENCY



OUTPUT POWER vs. INPUT POWER



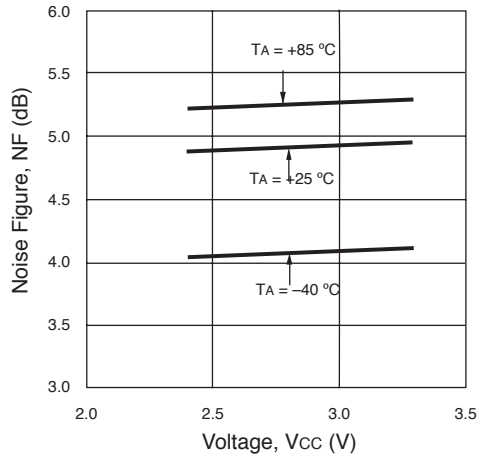
THIRD ORDER INTERMODULATION DISTORTION vs. OUTPUT POWER OF EACH TONE



TYPICAL PERFORMANCE CURVES (Unless otherwise specified, T_A = 25°C)

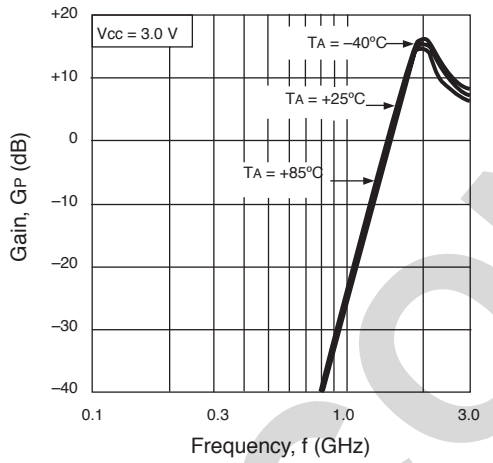
1.0 GHz Output Port Matching

NOISE FIGURE vs. VOLTAGE

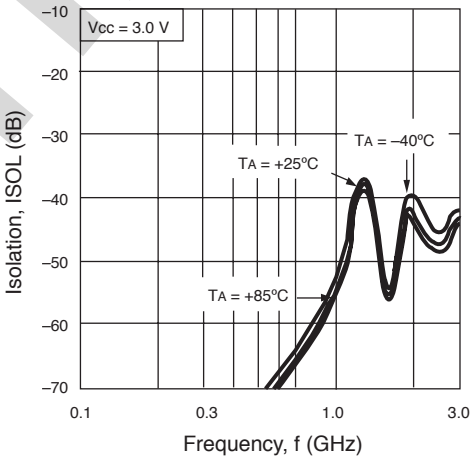


1.9 GHz Output Port Matching

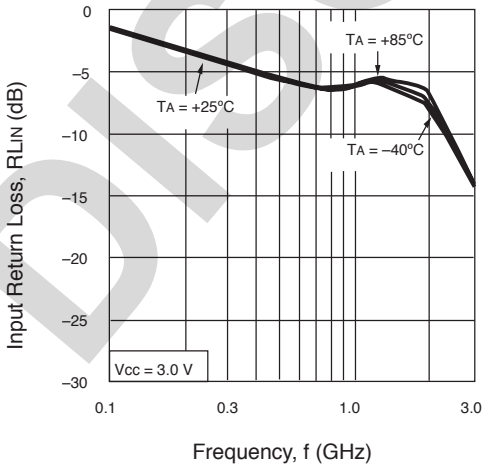
GAIN vs. FREQUENCY



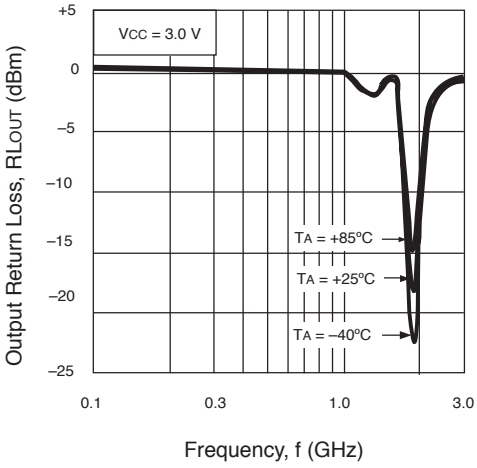
ISOLATION vs. FREQUENCY



INPUT RETURN LOSS vs. FREQUENCY



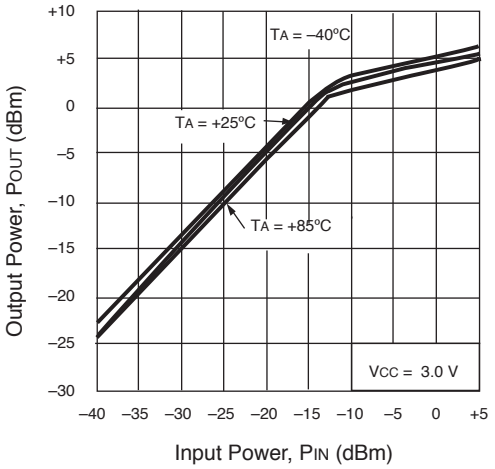
OUTPUT RETURN LOSS vs. FREQUENCY

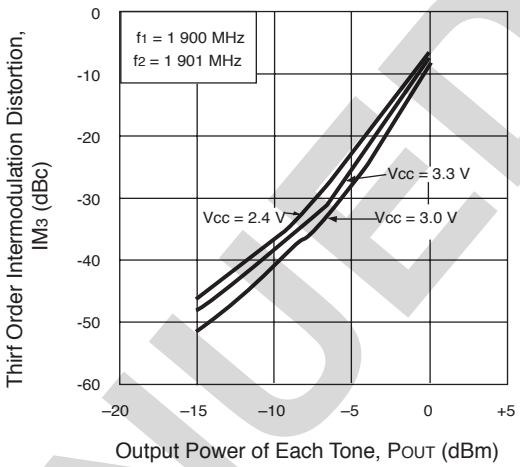


TYPICAL PERFORMANCE CURVES (Unless otherwise specified, T_A = 25°C)

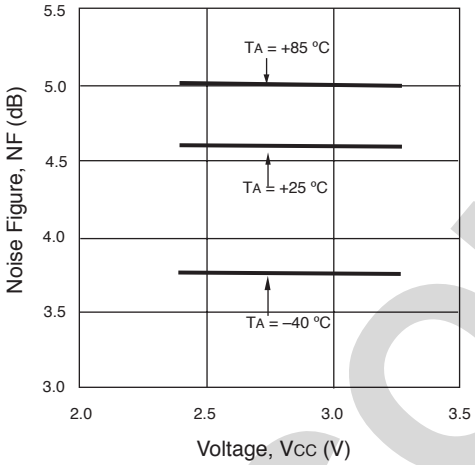
1.9 GHz Output Port Matching

OUTPUT POWER vs. INPUT POWER



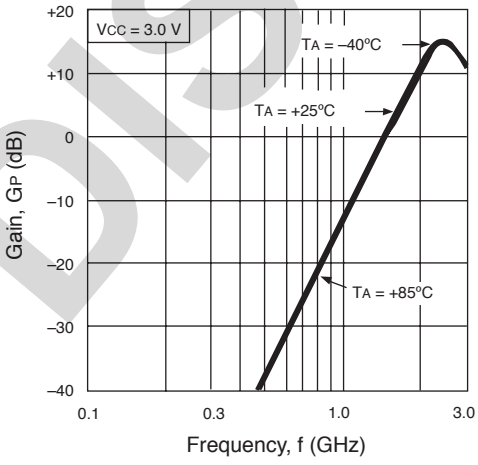


NOISE FIGURE vs. VOLTAGE

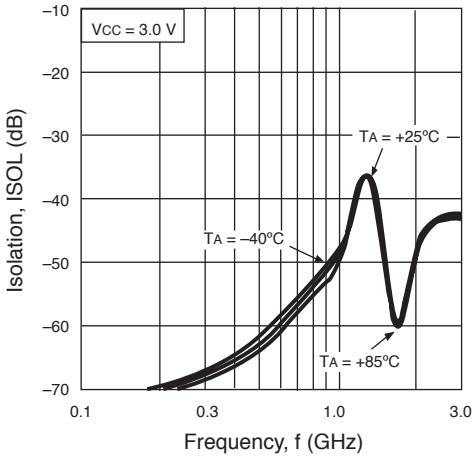


2.4 GHz Output Port Matching

GAIN vs. FREQUENCY



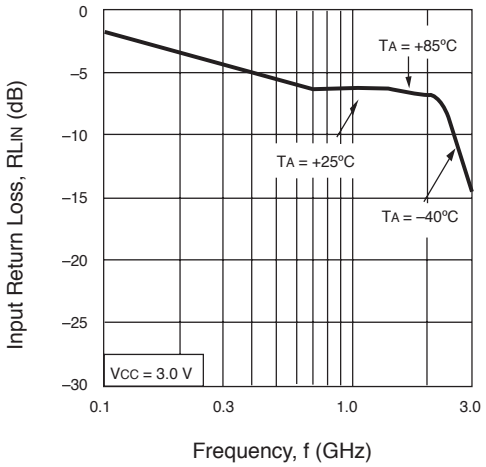
ISOLATION vs. FREQUENCY



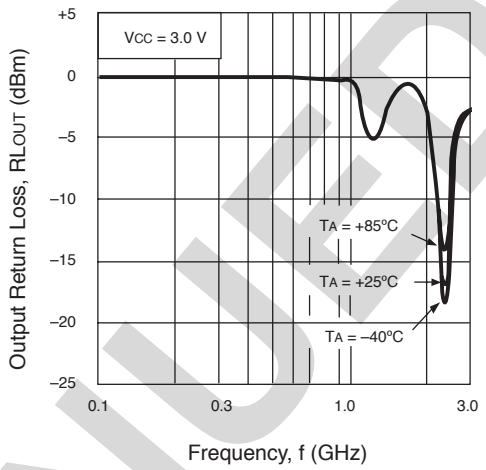
TYPICAL PERFORMANCE CURVES (Unless otherwise specified, T_A = 25˚C)

2.4 GHz Output Port Matching

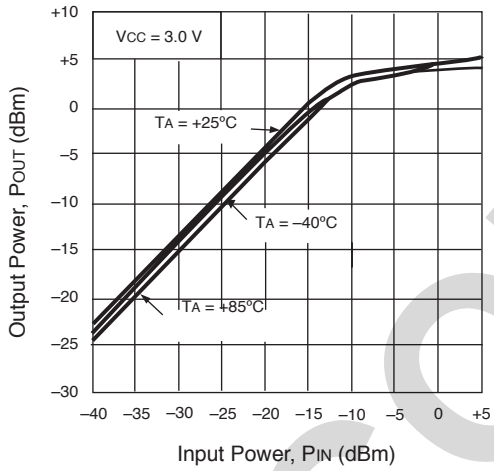
INPUT RETURN LOSS vs. FREQUENCY



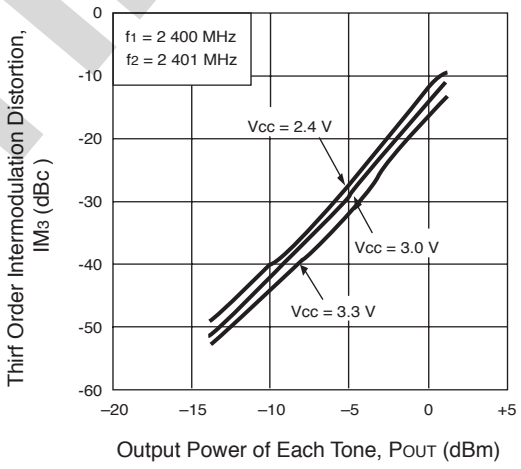
OUTPUT RETURN LOSS vs. FREQUENCY



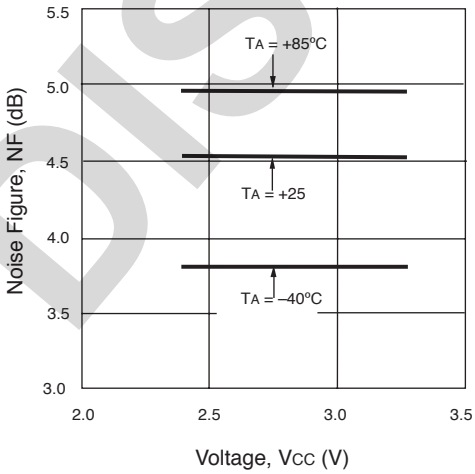
OUTPUT POWER vs. INPUT POWER



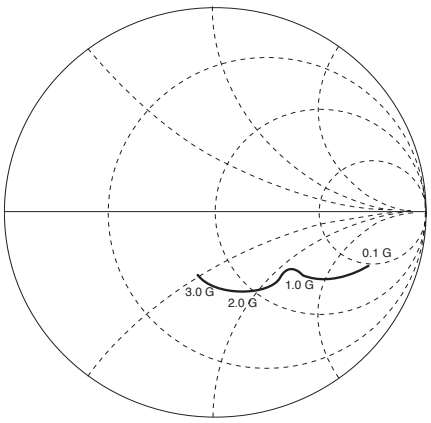
THIRD ORDER INTERMODULATION DISTORTION vs. OUTPUT POWER OF EACH TONE



NOISE FIGURE vs. VOLTAGE

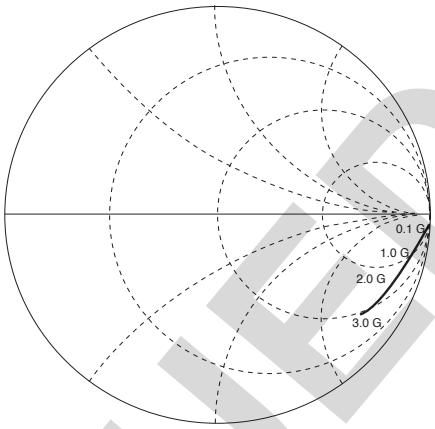


TYPICAL SCATTERING PARAMETERS (T_A = 25°C)



S11

Coordinates in Ohms
Frequency in GHz
V_{CC} = V_{OUT} = 3.0 V, I_{CC} = 4.0 mA



S22

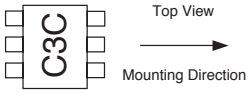
V_{CC} = V_{OUT} = 3.0 V, I_{CC} = 4.0 mA

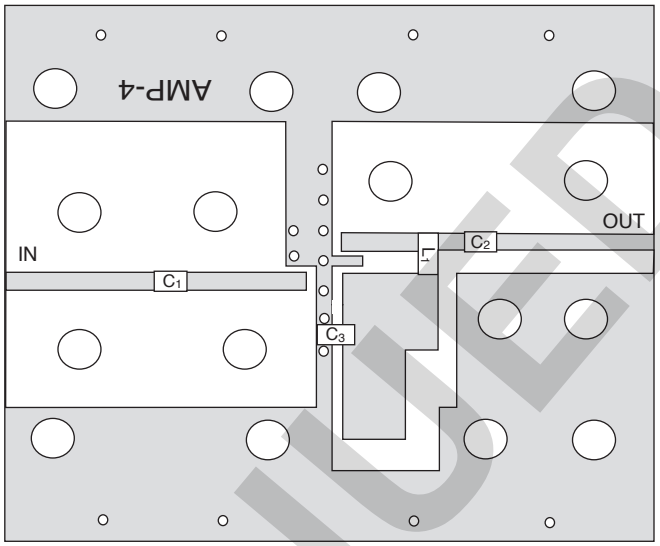
FREQUENCY	S_{11}		S_{21}		S_{12}		S_{22}	
GHz	MAG	ANG	MAG	ANG	MAG	ANG	MAG	ANG
0.1	0.824	-17.1	1.181	-177.7	0.002	108.8	0.996	-2.4
0.2	0.692	-25.9	1.181	-172.4	0.003	64.7	0.986	-4.0
0.3	0.594	-29.2	1.247	-167.4	0.004	51.3	0.980	-5.8
0.4	0.533	-30.7	1.370	-164.1	0.005	55.8	0.965	-7.5
0.5	0.499	-31.1	1.514	-162.4	0.005	60.6	0.958	-8.6
0.6	0.474	-32.0	1.677	-162.9	0.006	46.6	0.950	-10.1
0.7	0.460	-32.7	1.885	-163.8	0.006	42.9	0.941	-11.2
0.8	0.450	-34.0	2.050	-166.3	0.006	45.9	0.935	-12.4
0.9	0.441	-35.6	2.237	-169.2	0.005	42.1	0.929	-13.8
1.0	0.438	-37.7	2.460	-173.1	0.007	34.0	0.918	-14.9
1.1	0.431	-39.8	2.627	-177.3	0.007	46.9	0.914	-16.0
1.2	0.426	-42.0	2.772	178.4	0.005	27.7	0.903	-17.0
1.3	0.427	-44.8	2.965	173.2	0.005	40.2	0.895	-18.3
1.4	0.417	-48.1	3.123	168.0	0.004	24.4	0.891	-19.5
1.5	0.413	-50.6	3.199	161.8	0.006	45.5	0.884	-20.4
1.6	0.408	-54.6	3.351	156.8	0.005	44.6	0.877	-21.1
1.7	0.398	-57.6	3.345	151.2	0.003	42.4	0.867	-22.1
1.8	0.387	-61.6	3.103	145.5	0.005	44.6	0.877	-21.1
1.9	0.380	-64.9	3.361	140.9	0.005	59.5	0.859	-24.4
2.0	0.366	-69.1	3.375	136.3	0.004	45.4	0.852	-25.1
2.1	0.352	-72.1	3.350	132.3	0.003	58.3	0.846	-25.9
2.2	0.341	-75.6	3.304	127.9	0.003	73.9	0.847	-26.4
2.3	0.330	-79.4	3.347	124.8	0.006	81.1	0.839	-27.4
2.4	0.320	-82.4	3.325	121.2	0.006	98.3	0.839	-28.2
2.5	0.304	-85.6	3.275	117.3	0.006	100.5	0.838	-29.1
2.6	0.296	-88.2	3.284	113.7	0.004	114.6	0.834	-29.7
2.7	0.285	-91.7	3.283	111.0	0.005	104.8	0.830	-30.6
2.8	0.272	-94.3	3.224	106.5	0.005	114.1	0.831	-31.4
2.9	0.267	-96.9	3.333	104.3	0.008	127.8	0.837	-32.0
3.0	0.256	-99.5	3.251	101.1	0.009	126.3	0.831	-33.4
3.1	0.248	-101.9	3.381	96.0	0.008	134.1	0.833	-34.0

ILLUSTRATION OF THE TEST CIRCUIT ASSEMBLED ON EVALUATION BOARD

COMPONENT LIST

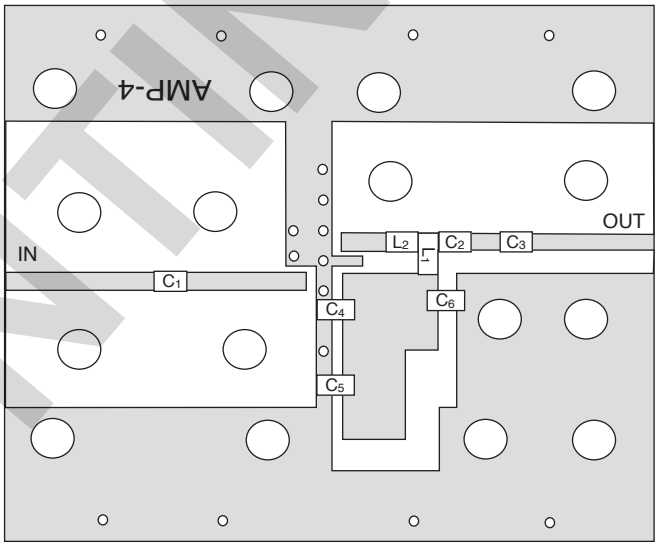
	1.0 GHz Output Port Matching
C_1	1000 pF
C_2	0.75 pF
C_3	10 pF
L_1	12 nH





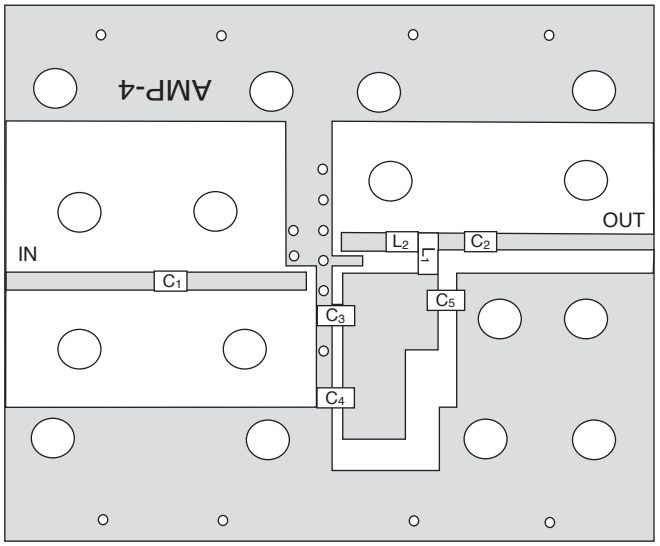
COMPONENT LIST

	1.9GHz Output Port Matching
C_1, C_3, C_5, C_6	1000 pF
C_2	0.75 pF
C_4	10 pF
L_1	3.3 nH



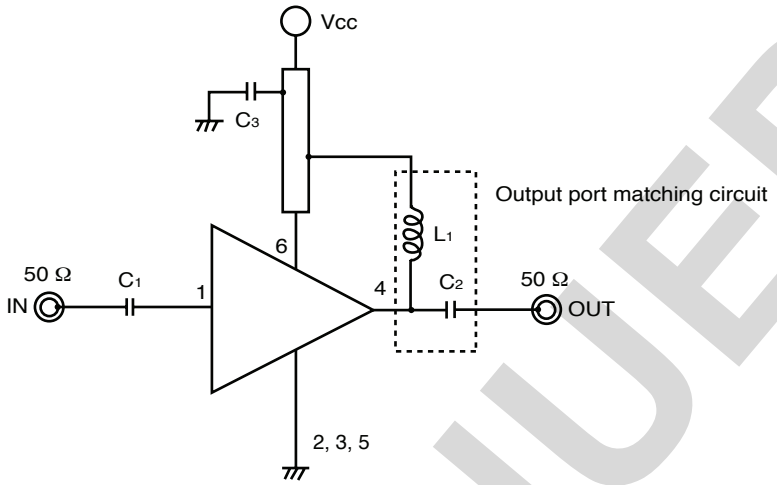
COMPONENT LIST

	2.4 GHz Output Port Matching
C_1, C_2, C_4, C_5	1000 pF
C_3	10 pF
L_1	1.8 nH
L_2	2.7 nH

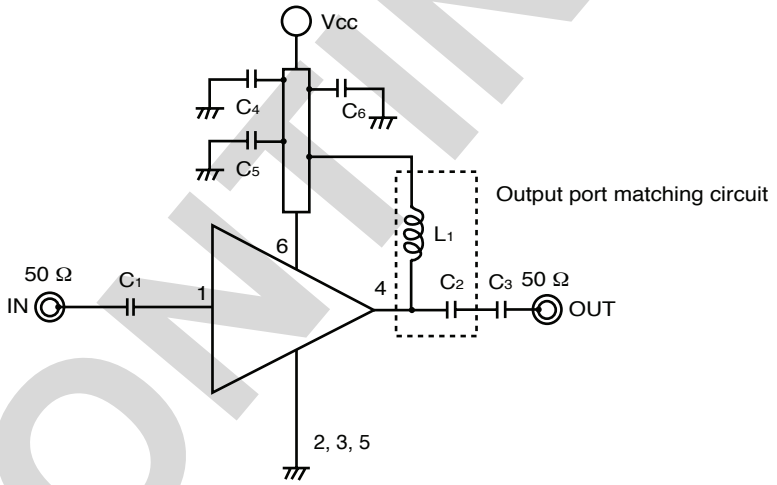


TEST CIRCUITS

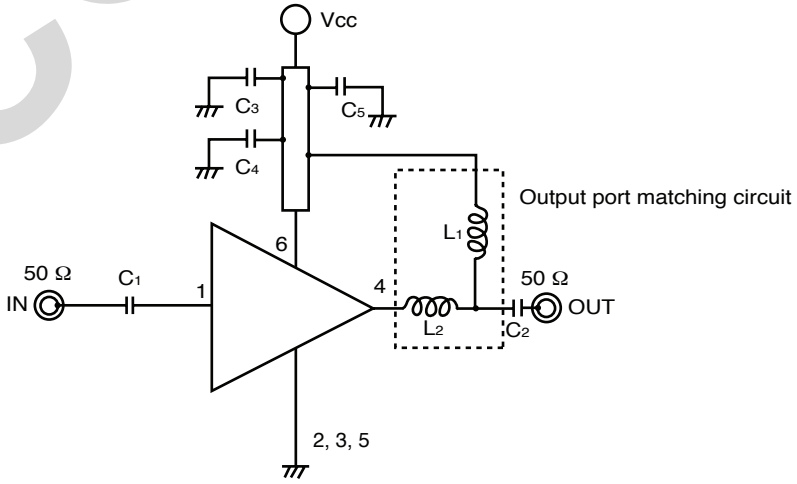
<1> f = 1.0 GHz



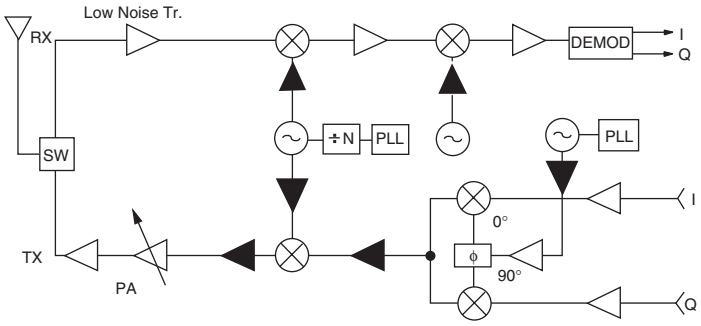
<2> f = 1.9 GHz



<3> f = 2.4 GHz

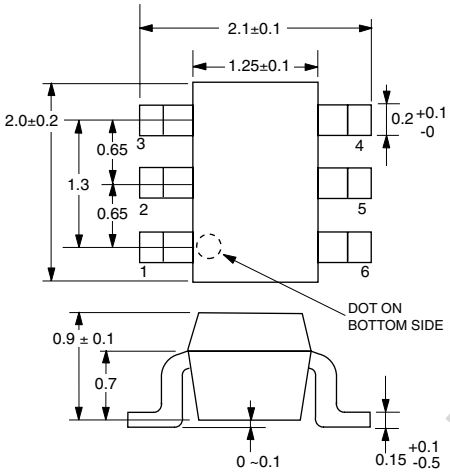


SYSTEM APPLICATION EXAMPLE

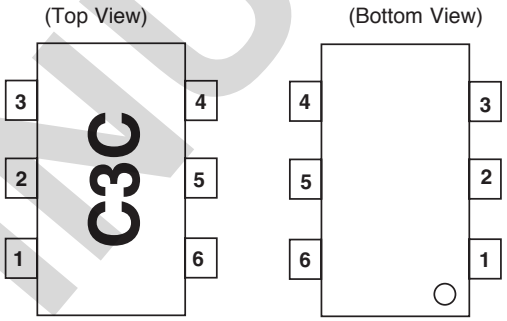


OUTLINE DIMENSIONS (Units in mm)

PACKAGE OUTLINE S06



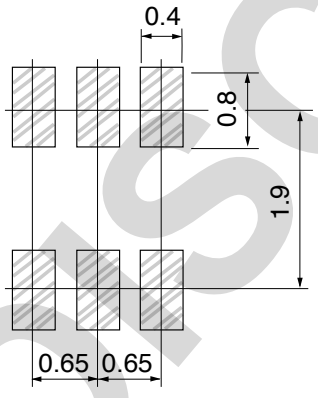
LEAD CONNECTIONS



1. INPUT
2. GND
3. GND
4. OUTPUT
5. GND
6. Vcc

RECOMMENDED P.C.B. LAYOUT (Units in mm)

Note:
All dimensions are typical unless otherwise specified.



ORDERING INFORMATION

PART NUMBER	QTY
UPC8179TB-E3-A	3K/Reel

Note:

Embossed tape, 8 mm wide. Pins 1, 2, 3 are in tape pull-out direction.

CEL California Eastern Laboratories

4590 Patrick Henry Drive
Santa Clara, CA 95054-1817
Telephone: (408) 919-2500
Facsimile: (408) 988-0279

Subject: Compliance with EU Directives

CEL certifies, to its knowledge, that semiconductor and laser products detailed below are compliant with the requirements of European Union (EU) Directive 2002/95/EC Restriction on Use of Hazardous Substances in electrical and electronic equipment (RoHS) and the requirements of EU Directive 2003/11/EC Restriction on Penta and Octa BDE.

CEL Pb-free products have the same base part number with a suffix added. The suffix –A indicates that the device is Pb-free. The –AZ suffix is used to designate devices containing Pb which are exempted from the requirement of RoHS directive (*). In all cases the devices have Pb-free terminals. All devices with these suffixes meet the requirements of the RoHS directive.

This status is based on CEL's understanding of the EU Directives and knowledge of the materials that go into its products as of the date of disclosure of this information.

Restricted Substance per RoHS	Concentration Limit per RoHS (values are not yet fixed)	Concentration contained in CEL devices	
Lead (Pb)	< 1000 PPM	-A	-AZ
		Not Detected	(*)
Mercury	< 1000 PPM	Not Detected	
Cadmium	< 100 PPM	Not Detected	
Hexavalent Chromium	< 1000 PPM	Not Detected	
PBB	< 1000 PPM	Not Detected	
PBDE	< 1000 PPM	Not Detected	

If you should have any additional questions regarding our devices and compliance to environmental standards, please do not hesitate to contact your local representative.

Mouser Electronics

Authorized Distributor

Click to View Pricing, Inventory, Delivery & Lifecycle Information:

CEL:

UPC8179TB-EV09 UPC8179TB-EV22 UPC8179TB-EV19 UPC8179TB-EV24